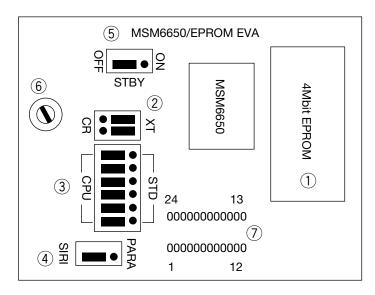
OKI Semiconductor This version: Feb. 1999 Previous version: May 1997 MSM6650 4MegOTP I/F BOARD

4MegOTP Conversion Board

1. BOARD APPEARANCE



2. BOARD SETTING

- 4Mbit EPROM Socket
 Insert a 4Mbit EPROM, which is programmed with the voice data through voice analysis.
- XT/RC Select jumpers
 These jumpers are used to select ceramic oscillation or RC oscillation.
 To select ceramic oscillation, set the jumpers 2 to the right side.
 To select RC oscillation, set the jumpers 2 to the left side.
 When a microcontroller is used, only ceramic oscillation can be selected.
- Stand-alone/Microcontroller Select Jumpers These jumpers are used to select Stand-alone Mode or Microcontroller Interface Mode for operation of the MSM6650. To select Stand-alone Mode, set the jumpers ③ to the right side. To select Microcontroller Interface Mode, set the jumpers ③ to the left side. However, set the jumper ④ to the right for Stand-alone Mode and the jumper ⑤ to the left for Microcontroller Interface Mode.
- (4) Serial Input Interface/Parallel Input Interface Select Swich When a microcontroller is used, this switch selects the serial input of addresses and command data or the parallel input of them. To select the serial input, set the switch to the left side. To select the parallel input, set the switch to the right side.

5 Stanby Select Jumper

When the jumper is set to the right side and The MSM6650 is not activated toward the next phrase within 0.2 second after the voice is terminated, the MSM6650 enters the standby state. (In the standby state, all functions of the MSM6650 are stopped.)

6 Variable Resistor for Adjusting Frequency of RC Oscillation

This variable resistor can change the frequency of RC oscillation. The frequency becomes low when the resistor is turned to the right, and the frequency becomes high when the resistor is turned to the left. (The oscillation frequency is set to 256kHz before shipment)

External Connection Pins The necessary signal lines are connected to the FC cable connector for external connections. The signals for each connector pin are described below.

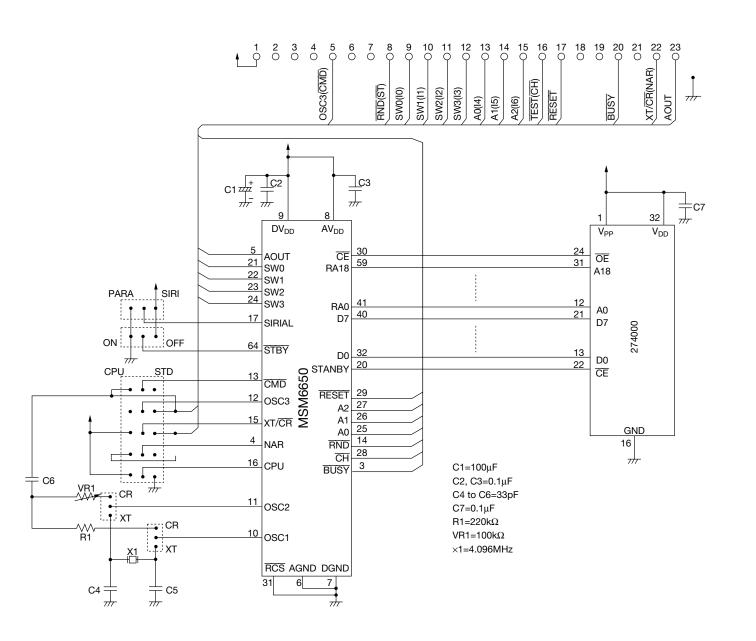
| Connector pin No. | Signal | Connector pin No. | Signal |
|-------------------|-----------------|-------------------|--------|
| 1 | V _{DD} | 13 | A0 |
| 2 | NC | 14 | A1 |
| 3 | NC | 15 | A2 |
| 4 | NC | 16 | TEST |
| 5 | OSC3 | 17 | RESET |
| 6 | NC | 18 | NC |
| 7 | NC | 19 | NC |
| 8 | RND | 20 | BUSY |
| 9 | SW0 | 21 | NC |
| 10 | SW1 | 22 | XT/CR |
| 11 | SW2 | 23 | AOUT |
| 12 | SW3 | 24 | GND |

Signals in Standalone Mode

Signals in Microcontroller Interface Mode

| Connector pin No. | Signal | Connector pin No. | Signal |
|-------------------|-----------------|-------------------|--------|
| 1 | V _{DD} | 13 | 14 |
| 2 | NC | 14 | 15/SI |
| 3 | NC | 15 | I6/SD |
| 4 | NC | 16 | CH |
| 5 | CMD | 17 | RESET |
| 6 | NC | 18 | NC |
| 7 | NC | 19 | NC |
| 8 | ST | 20 | BUSY |
| 9 | 10 | 21 | NC |
| 10 | 11 | 22 | NAR |
| 11 | I2/PORT0 | 23 | AOUT |
| 12 | I3/PORT1 | 24 | GND |

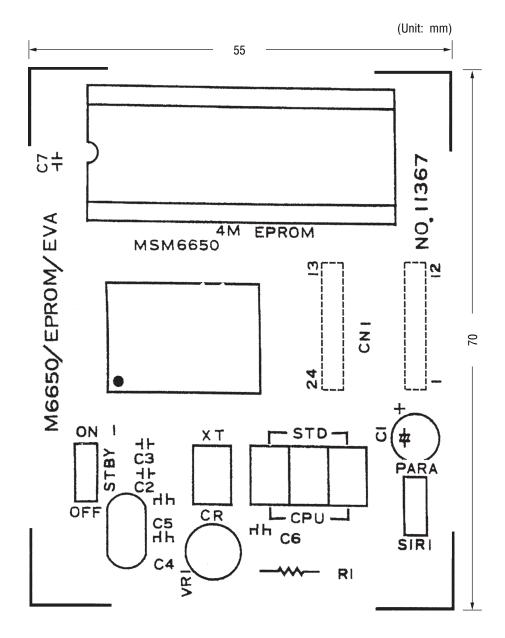
3. CIRCUIT DIAGRAM



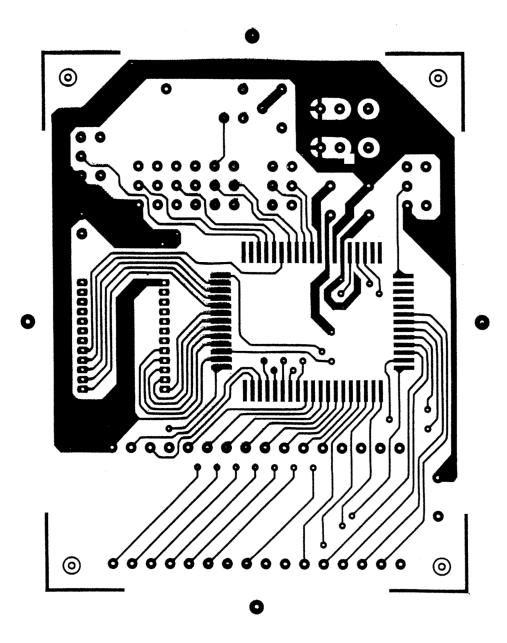
3/6

4. PATTERN LAYOUT

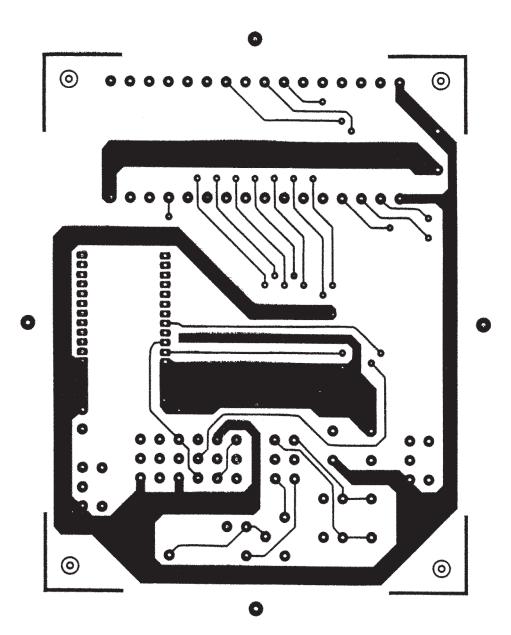
4-1. Silk Screen



4-2. Mounting Side



4-3. Solder Side



6/6

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